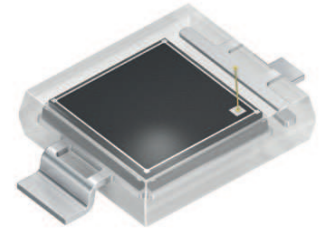


Silicon PIN Photodiode with Enhanced Blue Sensitivity; in SMT Version 1.7

BPW 34 BS



Features:

- Especially suitable for applications from 350 nm to 1100 nm
- Short switching time (typ. 25 ns)
- DIL plastic package with high packing density

Applications

- Photointerrupters
- Industrial electronics
- For control and drive circuits

Ordering Information

| Type: | Photocurrent I_P [μA] $\lambda = 400 \text{ nm}$, $E_e = 1 \text{ mW/cm}^2$, $V_R = 5 \text{ V}$ | Ordering Code |
|-----------|---|---------------|
| BPW 34 BS | 14.8 (≥ 10.8) | Q65110A2625 |

Maximum Ratings ($T_A = 25\text{ °C}$)

| Parameter | Symbol | Values | Unit |
|---|-------------------|------------|------|
| Operating and storage temperature range | $T_{op}; T_{stg}$ | -40 ... 85 | °C |
| Reverse voltage | V_R | 32 | V |
| Total Power dissipation | P_{tot} | 150 | mW |
| ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM) | V_{ESD} | 2000 | V |

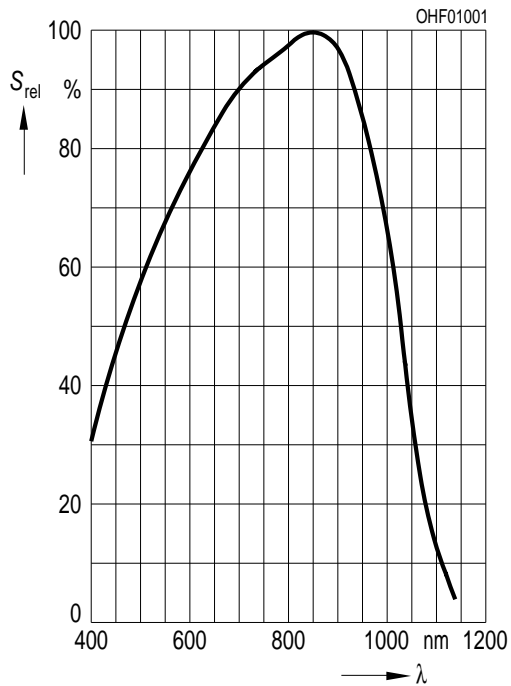
Characteristics ($T_A = 25\text{ °C}$)

| Parameter | Symbol | Values | Unit | |
|---|-------------|--------------------------|-----------------------|--------------------|
| Spectral sensitivity ($V_R = 5\text{ V}$, standard light A, $T = 2856\text{ K}$) | (typ) | S | 75 | nA/lx |
| Photocurrent ($V_R = 5\text{ V}$, $E_e = 1\text{ mW/cm}^2$, $\lambda = 400\text{ nm}$) | (typ (min)) | I_P | 14.8 (≥ 10.8) | μA |
| Wavelength of max. sensitivity | (typ) | $\lambda_{S\text{ max}}$ | 850 | nm |
| Spectral range of sensitivity | (typ) | $\lambda_{10\%}$ | (typ) 350 ... 1100 | nm |
| Radiant sensitive area | (typ) | A | 7.45 | mm^2 |
| Dimensions of radiant sensitive area | (typ) | L x W | 2.73 x 2.73 | mm x mm |
| Half angle | (typ) | φ | ± 60 | ° |
| Dark current ($V_R = 10\text{ V}$) | (typ (max)) | I_R | 2 (≤ 30) | nA |
| Spectral sensitivity of the chip ($\lambda = 400\text{ nm}$) | (typ) | $S_{\lambda\text{ typ}}$ | 0.0 | A / W |
| Quantum yield of the chip ($\lambda = 400\text{ nm}$) | (typ) | η | 0.00 | Electrons / Photon |
| Open-circuit voltage ($E_v = 1000\text{ lx}$, Std. Light A) | (typ (min)) | V_O | 390 | mV |
| Short-circuit current ($E_e = 0.5\text{ mW/cm}^2$, $\lambda = 400\text{ nm}$) | (typ) | I_{SC} | 7.4 | μA |
| Rise and fall time ($V_R = 5\text{ V}$, $R_L = 50\ \Omega$, $\lambda = 850\text{ nm}$) | (typ) | t_r, t_f | 0.025 | μs |
| Forward voltage ($I_F = 100\text{ mA}$, $E = 0$) | (typ) | V_F | 1.3 | V |
| Capacitance ($V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$) | (typ) | C_0 | 72 | pF |
| Temperature coefficient of V_O | (typ) | TC_V | -2.6 | mV / K |

| Parameter | | Symbol | Values | Unit |
|---|-------|--------|-----------------|---|
| Temperature coefficient of I_{SC} (Std. Light A) | (typ) | TC_1 | 0.18 | % / K |
| Noise equivalent power ($V_R = 10\text{ V}$, $\lambda = 400\text{ nm}$) | (typ) | NEP | 1.#INF | $\text{pW} / \text{Hz}^{1/2}$ |
| Detection limit | (typ) | D^* | 0.0e-2147483648 | $\text{cm} \times \text{Hz}^{1/2} / \text{W}$ |

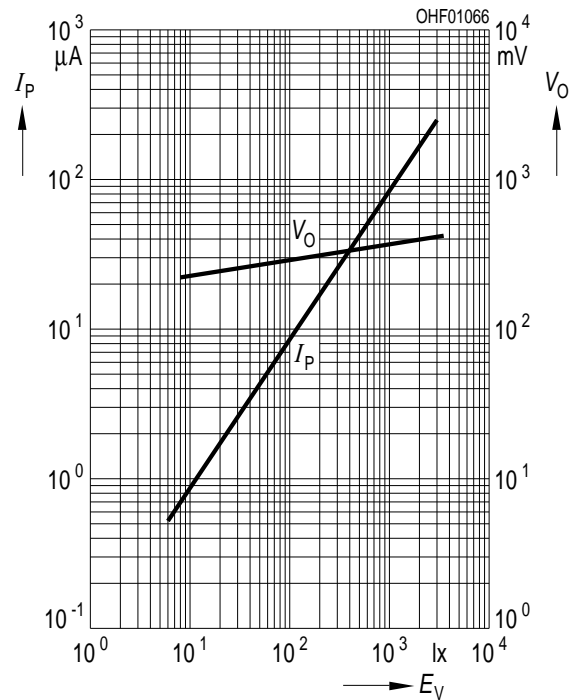
Relative Spectral Sensitivity ^{1) page 11}

$S_{rel} = f(\lambda)$



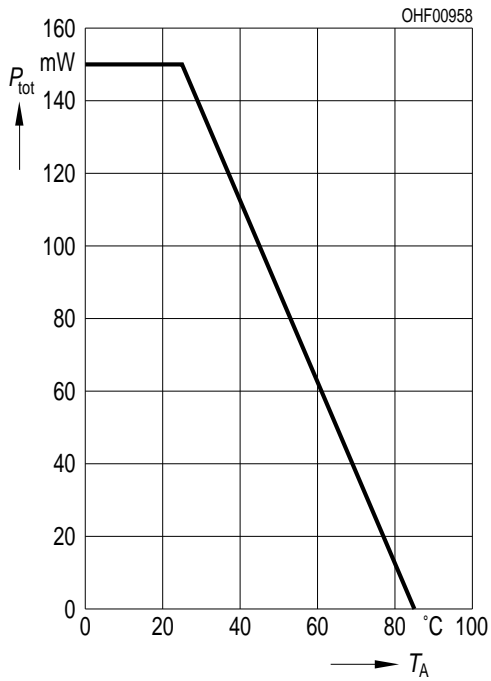
Photocurrent / Open-Circuit Voltage ^{1) page 11}

$I_P (V_R = 5\text{ V}) / V_O = f(E_V)$



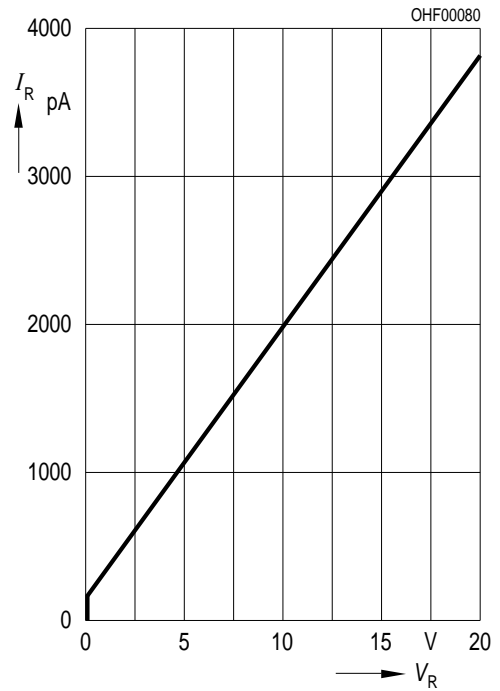
Power Consumption

$P_{tot} = f(T_A)$



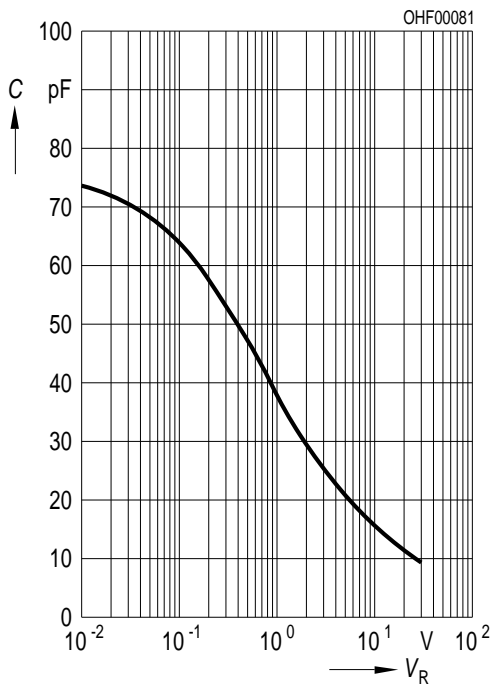
Dark Current ^{1) page 11}

$I_R = f(V_R), E = 0$



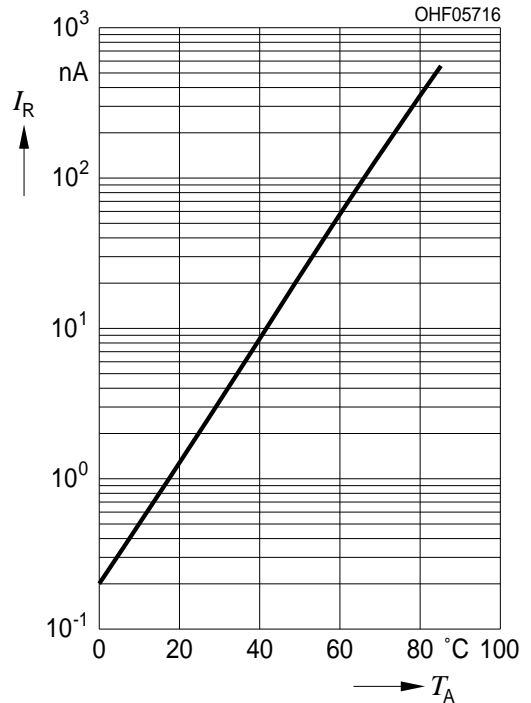
Capacitance ^{1) page 11}

$C = f(V_R), f = 1 \text{ MHz}, E = 0$



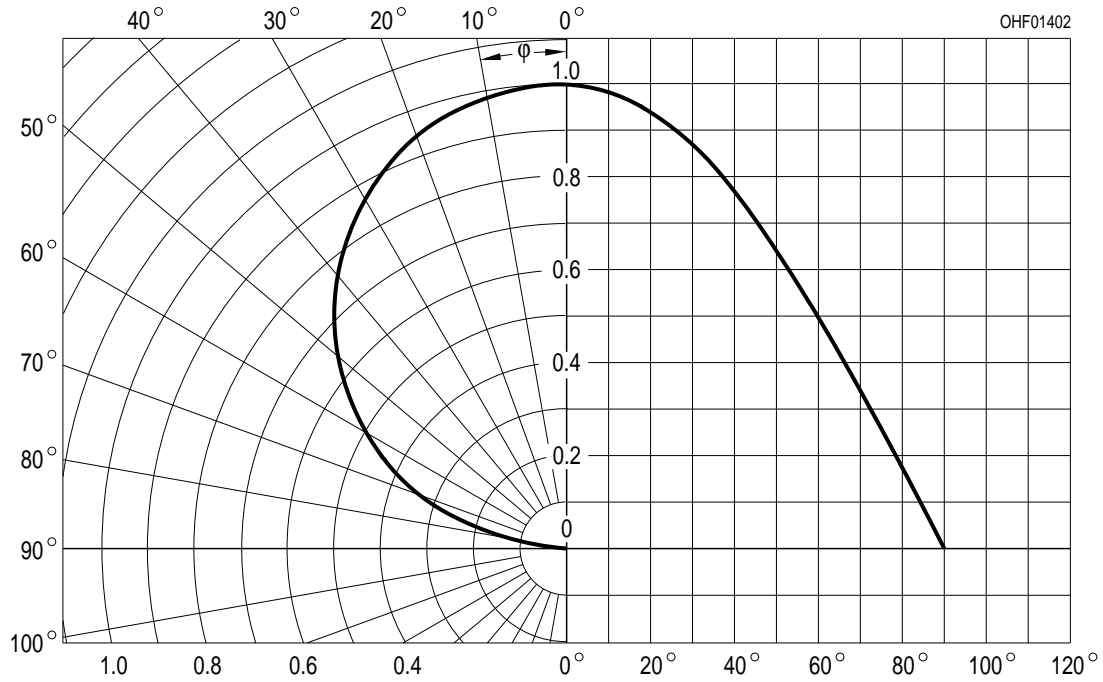
Dark Current ^{1) page 11}

$I_R = f(T_A), V_R = 10 \text{ V}, E = 0$

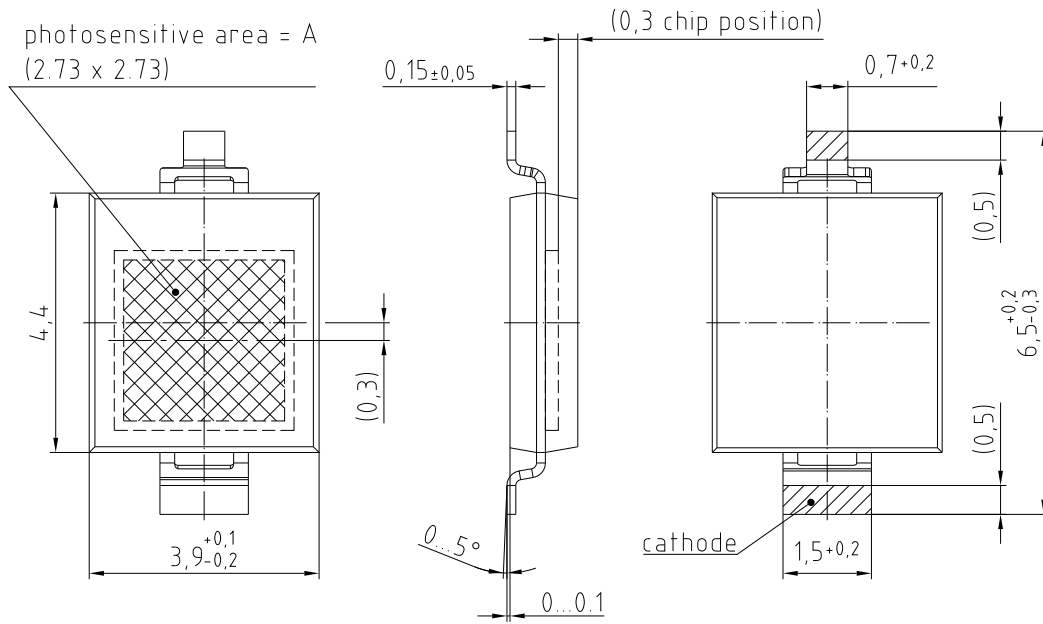


Directional Characteristics ^{1) page 11}

$S_{rel} = f(\phi)$



Package Outline



general tolerance ± 0.1
 lead finish Sn

C63062-A3171-A5-01

Dimensions in mm.

Package

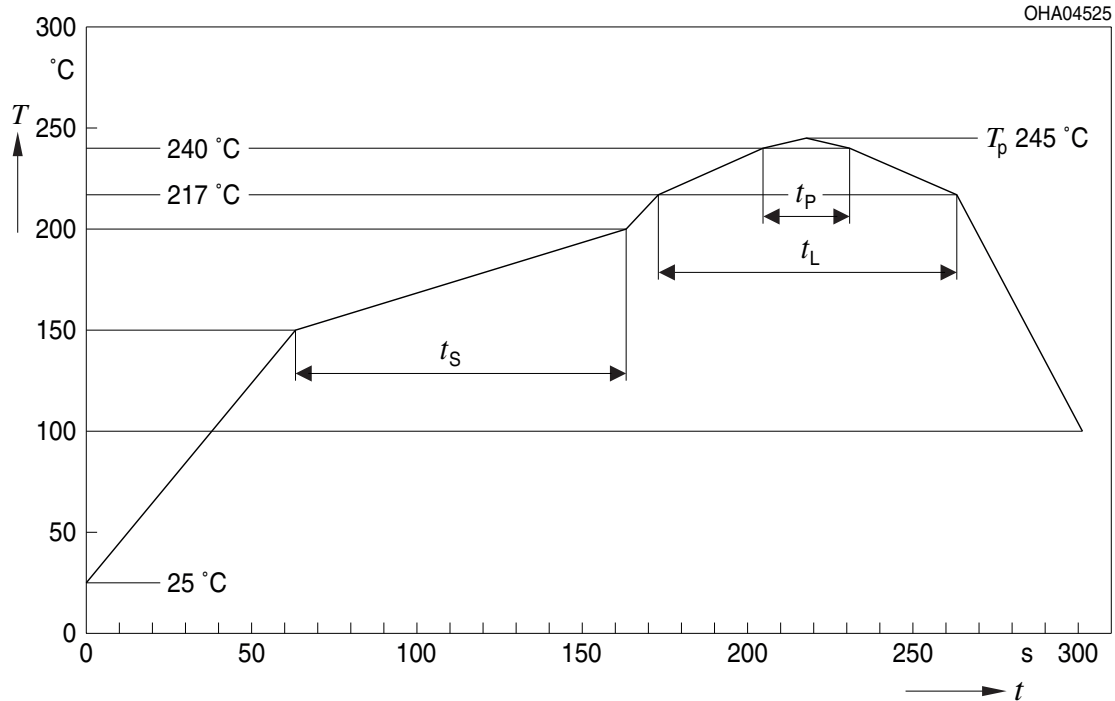
SMT DIL, Epoxy

Approximate Weight:

44 mg

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020E



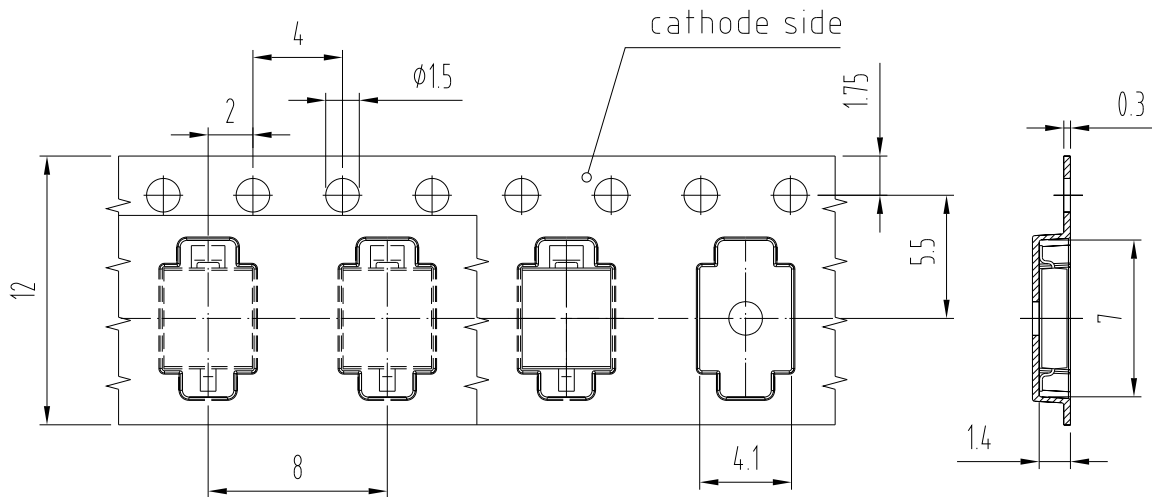
OHA04612

| Profile Feature Profil-Charakteristik | Symbol Symbol | Pb-Free (SnAgCu) Assembly | | | Unit Einheit |
|---|------------------|---------------------------|----------------|---------|-----------------|
| | | Minimum | Recommendation | Maximum | |
| Ramp-up rate to preheat*) 25 °C to 150 °C | | | 2 | 3 | K/s |
| Time t_s T_{Smin} to T_{Smax} | t_s | 60 | 100 | 120 | s |
| Ramp-up rate to peak*) T_{Smax} to T_p | | | 2 | 3 | K/s |
| Liquidus temperature | T_L | 217 | | | °C |
| Time above liquidus temperature | t_L | | 80 | 100 | s |
| Peak temperature | T_p | | 245 | 260 | °C |
| Time within 5 °C of the specified peak temperature $T_p - 5$ K | t_p | 10 | 20 | 30 | s |
| Ramp-down rate* T_p to 100 °C | | | 3 | 6 | K/s |
| Time 25 °C to T_p | | | | 480 | s |

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping

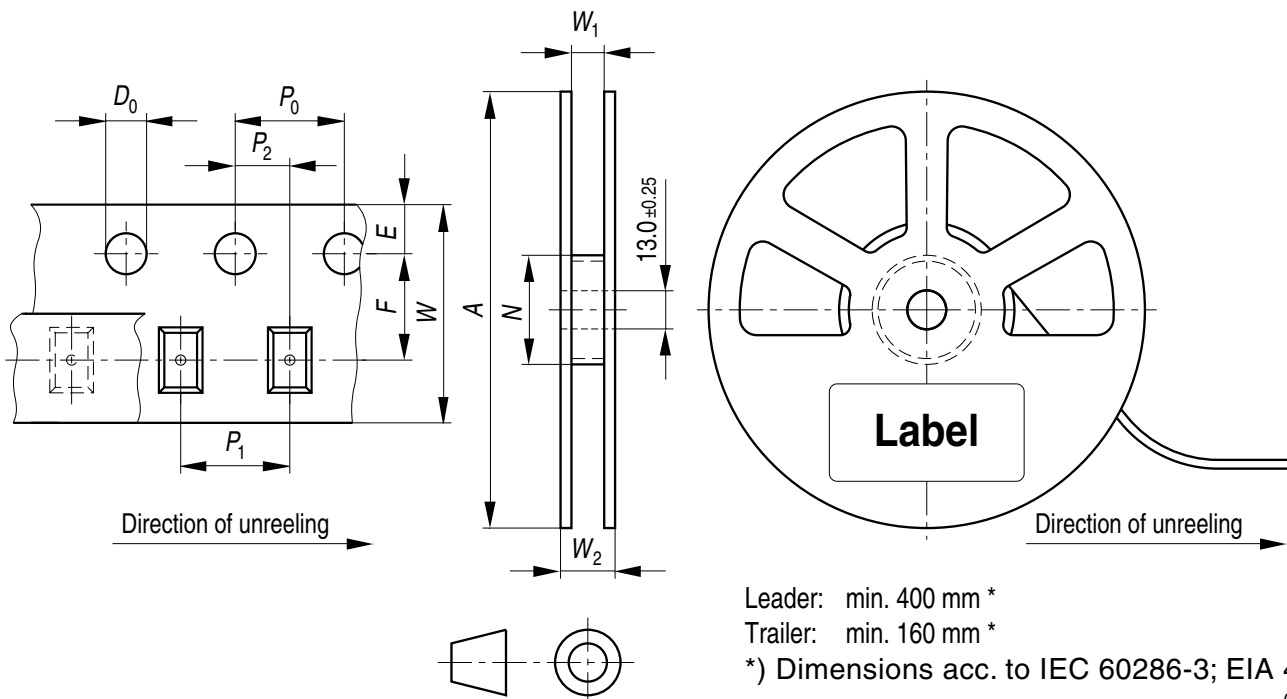


C63062-A3171-B8-04

Dimensions in mm.

Tape and Reel

12 mm tape with 1500 pcs. on $\phi 180$ mm reel



Leader: min. 400 mm *

Trailer: min. 160 mm *

*) Dimensions acc. to IEC 60286-3; EIA 481-D

OHAY0324

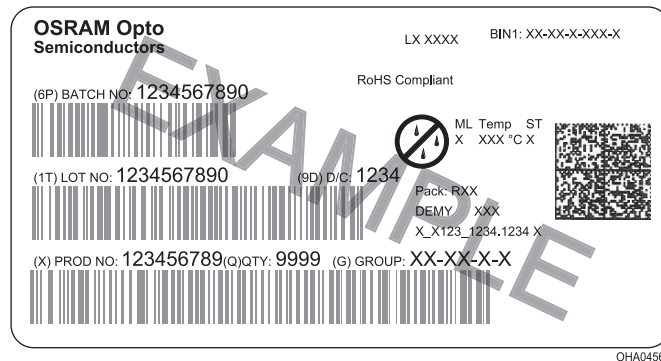
Tape dimensions [mm]

| W | P ₀ | P ₁ | P ₂ | D ₀ | E | F |
|------------------|----------------|--------------------------|----------------|----------------|------------|------------|
| 12 + 0.3 / - 0.1 | 4 ± 0.1 | 4 ± 0.1 or 8 ± 0.1 | 2 ± 0.05 | 1.5 ± 0.1 | 1.75 ± 0.1 | 5.5 ± 0.05 |

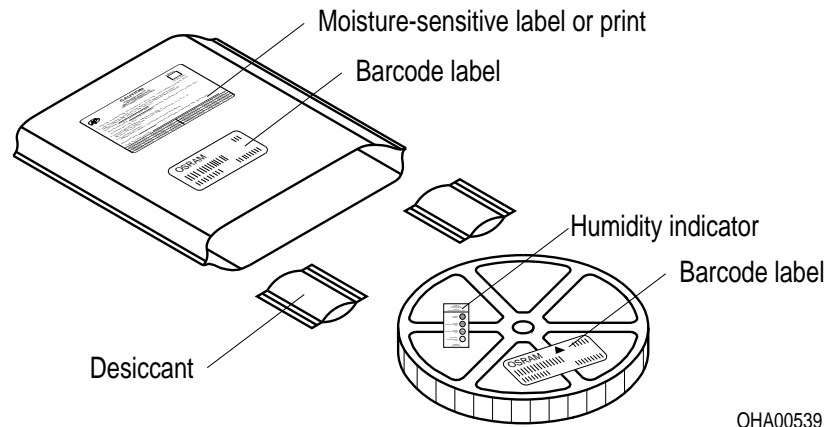
Reel dimensions [mm]

| A | W | N _{min} | W ₁ | W _{2max} |
|-----|----|------------------|----------------|-------------------|
| 180 | 12 | 60 | 12.4 + 2 | 18.4 |

Barcode-Product-Label (BPL)



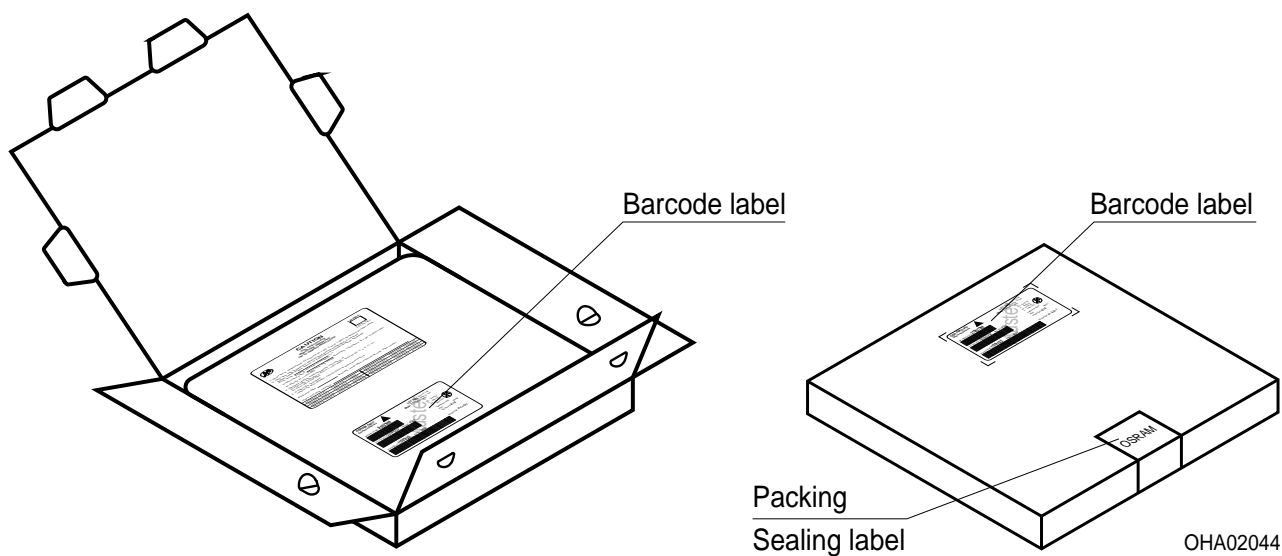
Dry Packing Process and Materials



Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

Transportation Packing and Materials



Dimensions of transportation box in mm

| Width | Length | Height |
|---------|---------|--------|
| 195 ± 5 | 195 ± 5 | 30 ± 5 |

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

- ¹⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

Published by OSRAM Opto Semiconductors GmbH
Leibnizstraße 4, D-93055 Regensburg
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EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，不含有毒有害物质或元素。

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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